PATENT

X



COMBINED INVENTOR DECLARATION AND POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next-to my name, I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

Viral deconstruction through capsid assembly in vitro

the specificat	ion of which		
[]	Is attached hereto.		
[]	Was filed on March 14, 20	05 and has been assig	gned Serial Number.
[X]	Was filed on March 14, 20	05 as Attorney Dock	et No. UCSF.0N.00US

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose all information known to me to be material to patentability of this application as defined in Title 37, Code of Federal Regulations, §1.56 and, if applicable, all such information under 37 CFR § 1.56 which became available between the national or PCT International filing date of the prior application and the filing date of this application.

I hereby claim foreign priority benefits under Title 35, United States Sode §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

PATENT

ATTORNEY DOCKET NO. UCSF.011.00US

Prior Foreign Application(s)

PCT/US03/28622 WIPO 11/9/2003 [] [] (number) (Country) (Day/Month/Year Filed) Yes No

I hereby claim the benefit under Title 35, United States Code, §119(e) of any provisional application and §120 of any non-provisional United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 USC §112 I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application.

60/410,572 13/9/2002 Expired (number) (Day/Month/Year Filed) (Status)

I hereby appoint

BARBARA RAE-VENTER, Ph.D., Reg. No. 32,750

as my attorney(s) or agent(s) with full power of substitution and revocation to prosecute my above-identified application for Letters Patent and to transact all business in the Patent Office connected therewith.

Direct all telephone calls to Barbara Rae-Venter, Ph.D. at: (831) 648-3090.

Address all correspondence to

PATENT

ATTORNEY DOCKET NO. UCSF.011.00US

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or fir	st inventor: Jairam R. Lingappa
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Date:	
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ATTORNEY DOCKET NO. UCSF.011.00US

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Inventor's signature:	
Date:	
Residence:	··
Citizenship:	
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